General Description

The SJM20P090 uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as -2.5V. This device is suitable for use as a wide variety of applications.

Features

- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

Application

- PWM Applications
- Load Switch
- Power Management

Key Performance Parametes

Parameter	Value	Unit
V _{DS}	-20	٧
R _{DS(ON)_TYP}	7.6	mΩ
I _D	-56	Α
Q _G	36	nC



Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJM20P090	SJM20P090	PDFN3X3-8L	Tape	\	\	5000 Pcs

Table 1. Absolute Maximum Ratings (T_C=25℃ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V _{DS}	Drain-Source Voltage (V _{GS} =0V)	-20	V
V _G s	Gate-Source Voltage (V _{DS} =0V)	±12	V
1-	Drain Current-Continuous(Tc=25°ℂ)	-56	А
I _D Drain Current-Continuous(Tc=100℃)		-34	А
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	-220	А
Po	Maximum Power Dissipation(Tc=25°C)	42	W
PD	Maximum Power Dissipation(Tc=100°C)	17	W
Eas	Avalanche energy (Note 2)	90	mJ
T _J , T _{STG}	Operating Junction and Storage Temperature Range	-55 To 150	C

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
R _{BJC} Thermal Resistance, Junction-to-Case			3	°C/W



Table 3. Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off States						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =-250μA	-20			V
		V _{DS} =-20V, V _{GS} =0V T _J =25°C			-1	μΑ
IDSS	Zero Gate Voltage Drain Current	V _{DS} =-20V, V _{GS} =0V T _J =125℃			-100	μΑ
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±12V, V _{DS} =0V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-0.5		-1	V
g FS	Forward Transconductance	V _{DS} =-5V, I _D =-6A		23.9		S
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =-4.5V, I _D =-6A T _J =25°C		7.6	10	mΩ
R _{DS(ON)}	Drain-Source On-State Resistance	V _{GS} =-2.5V, I _D =-4A T _J =25°C		10.7	14.2	mΩ
Dynamic Chara	acteristics					ı
Ciss	Input Capacitance			2711		pF
Coss	Output Capacitance	V _{DS} =-10V,V _{GS} =0V, f=1.0MHz		321		pF
Crss	Reverse Transfer Capacitance			269		pF
Rg	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		8.3		Ω
Switching Para	meters				l	
t _{d(on)}	Turn-on Delay Time			16.6		nS
t _r	Turn-on Rise Time	V _{GS} =-4.5V, V _{DS} =-10V,		33.2		nS
$t_{d(off)}$	Turn-Off Delay Time	R_L =1.5Ω, R_{GEN} =6Ω		128.4		nS
t _f	Turn-Off Fall Time			67.2		nS
Qg	Total Gate Charge			36		nC
Q_{gs}	Gate-Source Charge	V _{GS} =-4.5V, V _{DS} =-10V, I _D =-6A		7		nC
Q_{gd}	Gate-Drain Charge			9		nC
Source-Drain D	Piode Characteristics			1	I	I
I _{SD}	Source-Drain Current (Body Diode)				-56	Α
V _{SD}	Forward on Voltage (Note 3)	V _{GS} =0V, I _S =-6A			-1.2	V
t _{rr}	Reverse Recovery Time	I=-6A, dI/dt=-100A/μs		16.8		ns
Qrr	Reverse Recovery Charge	I _F =-6A, dI/dt=-100A/μs		5.1		nC
		i .	1		1	

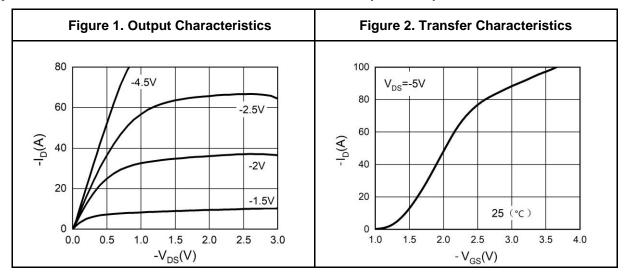
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

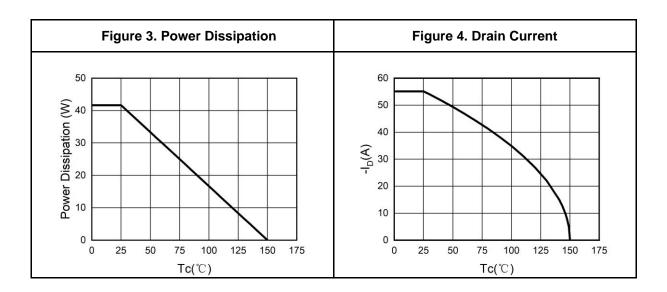
Notes 2.E_{AS} condition: $T_J=25^{\circ}C$, $V_{DD}=-20V$, $V_{G}=-10V$, $Rg=25\Omega$, L=0.5mH.

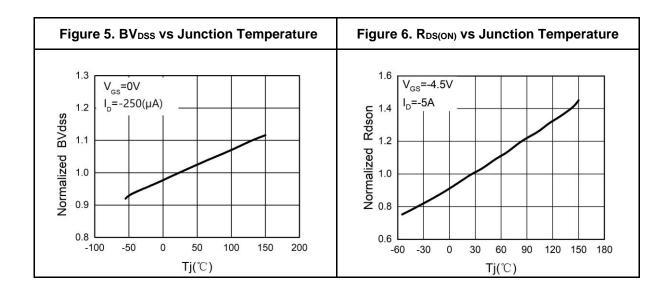
Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



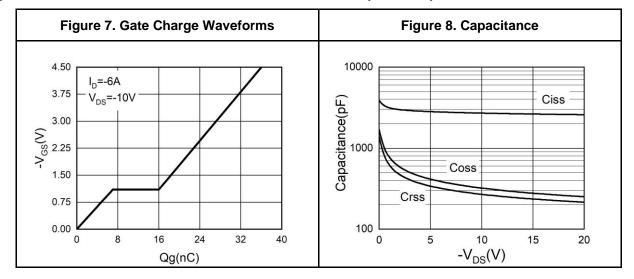
Typical Electrical And Thermal Characteristics (Curves)

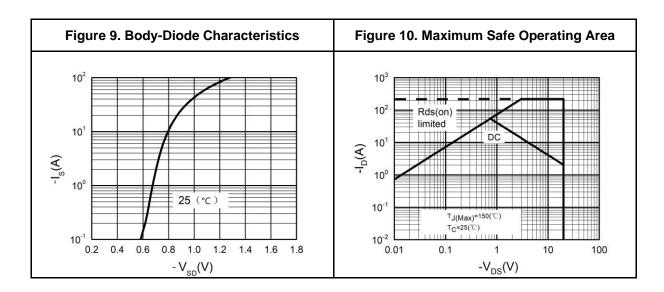






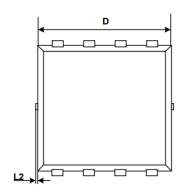
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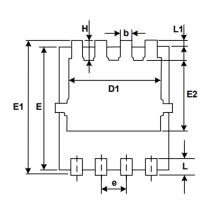


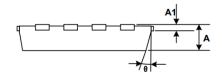




PDFN3X3-8L Package Information







COMMON DIMENSIONS

SYMBOL	MM			
STIVIBOL	MIN	MAX		
Α	0.65	0.90		
A1	0.10	0.25		
D	2.90	3.25		
D1	2.25	2.69		
E	2.90	3.20		
E1	3.00	3.60		
E2	1.35	2.20		
b	0.20	0.40		
е	0.65BSC			
L	0.15	0.50		
L1	0.13BSC			
L2	0.00	0.20		
Н	0.15	0.65		
θ	0°	14°		



Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

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